

MP-S01

Part No. 3110-0001

Test Report

Product Specification no. PRS-2227

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0	T19012	January 31, 2019	S.Kamada	-	T.Hirakawa
Rev.	ECN	Date	Prepared by	Checked by	Approved by

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MP-S01 Test Report

1. Purpose

To evaluate the performance of MP-S01 Connector in accordance with PRS-2227.

2. Specimen

MP-S01 (Part No. 3110-0001)

3. Test Sequence

All the evaluations were performed in accordance with Table 1.Test Sequence.

4. Result

See Table A to N, Graph 1 to 9. For the details of the testing conditions and requirements, see PRS-2227. The "n" in the tables show the number of measurement points.

5. Conclusion

All the specimens met the requirements of PRS-2227.

Table 1 Test Sequence and Sample Quantity

	Table	<u> </u>	631 06	quence	, and o	ampic	Quant	ıty					
Test Item	Group												
iest itelli		В	С	D	Е	F	G	Н	J	K	L	М	N
Contact resistance			1,4	1,3	1,3	1,3	1,3	1,3	1,3	1,3	1.3		2
Rated voltage/Current	1												
Contact force		1	3										
Durability			2										
Shock				2									
Vibration					2								
Cold test						2							
Heat test							2						
Thermal shock test								2					
Humidity (steady state)									2				
H₂S gas										2			
Saltwater spray											2		
Surface mount solderability test												1	
Resistance to reflow soldering heat													1
Specimen quantity	5	10	10	5	5	5	5	5	5	5	5	5	5

XNumbers indicate sequence in which tests are performed.

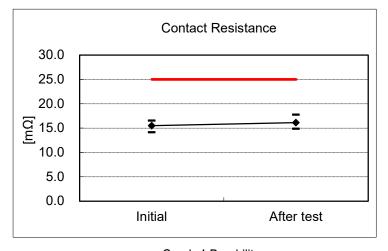
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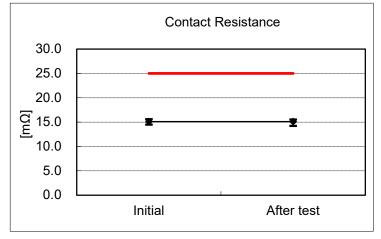
	_		Table.2-1 Test re	sult							
Group	Contents of n	neasurement	Spec. Unit				_	Judge.			
Α	Rated Voltage/Current		·	'		AVE.	S				
	Temperature		⊿T 30 MAX.	$^{\circ}$	5		26.0 M	1AX		ОК	
						<u>'</u>					
В	Contact Force	har to the same	To post servi	T	1		0.00				
		Working Height MAX Working Height MIN.		N	10	0.376	0.39	0.36	0.010 0.020	OK OK	
		TWO KING HEIGHT MIN.	0.9311 1147			0.050	0.03	0.00	0.020	OK	
С	Durability										
	Contact resistance	Initial	25 MAX	mΩ			16.570 1		0.821	OK	
		After 10 cycles Working Height MAX	0 30N MIN				17.800 1 0.380	0.350	0.888	OK OK	
	Contact Force	Working Height MIN.		N	10			0.590	0.016	OK	
			No abnormality	adversely		No abnor					
	Apearance	After test	affecting the			affecting	e shall	OK			
			performance shall occur.			occur.					
D	Shock										
	Contact resistance	Initial	25 MAX	mΩ		***************************************	15.628 1		0.490	OK	
		After test					15.561 1	14.262	0.595	OK OK	
	Electrical discontinuity	During test After test	1µs MAX - No abnormality adversely affecting the		5		No discontinuity No abnormality adversely				
	Apearance					affecting	ОК				
	•		performance sh	all occur.		occur.	•				
	Vibration										
E		Initial				15 201	15.855 1	14 546	0.492	ОК	
	Contact resistance	After test	25 MAX	mΩ			16.535 1		0.347	OK	
	Electrical discontinuity	During test	1µs MAX	-	5	No disco	OK				
	Apearance	After test	No abnormality adversely affecting the performance shall occur.			No abnor	OK				
						affecting occur.	OK				
	<u> </u>	I.	periornance on	an occur		occur					
F	Cold Test	T	1			T T	_			_	
	Contact resistance	Initial	25 MAX	mΩ			17.464 1 16.923 1		0.435 0.130	OK OK	
		After test	No abnormality	adverselv	5	No abnor				UK	
	Apearance	After test	affecting the	,		affecting	ОК				
			performance sh	all occur.		occur.					
G	Heat Test										
9		Initial	25.4437			16.277	16.813 1	15.635	0.482	ОК	
	Contact resistance	After test	~ 25 MAX	mΩ			16.937 1			OK	
	Apearance	After test	No abnormality adversely affecting the performance shall occur.		5	No abnor	•		-	211	
						affecting occur.	OK				
	l	1	Iperiornance Si	an occur.		Joccui.					
Н	Thermal Shock		_	1		,	3				
	Contact resistance	Initial	25 MAX	mΩ		***************************************	15.617 1		0.366	OK	
		After test	No abnormality		5	15.843 No abnor	16.172 1			OK	
	Apearance	After test	affecting the	auversery	<i>_</i>	affecting		ОК			
	,		performance sh	all occur.		occur.	1		-		
											

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Table.2-2 Test result

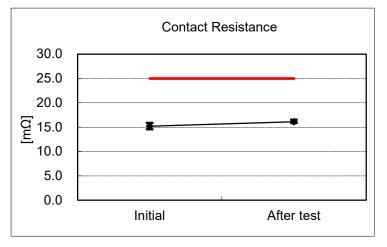
	Data													
Group	Contents of measurement		Spec.	Unit	n		Judge.							
			- 1			AVE.	MAX.	MIN.	S					
	<u> </u>	`												
J	Humidity(steady state		1	1										
	Contact resistance	Initial	25 MAX	mΩ			15.480		0.110	OK				
		After test					15.900		0.233	OK				
			No abnormality	adversely	5	No abno								
	Apearance	After test	affecting the			affecting	OK							
			performance sh	all occur.		occur.								
K	H ₂ S Gas		1	1	1		1							
	Contact resistance	Initial	25 MAX	mΩ			15.378		0.329	OK				
		After test					16.866		0.215	OK				
	Apearance	After test	No abnormality	5	No abnormality adversely									
			affecting the		affecting the performance shall				OK					
			performance shall occur.			occur.								
L	Salt water spray													
	Contact resistance	Initial	25 MAX	mΩ	5	16.041	16.859	15.130	0.668	OK				
		After test	23 MAX	11125		16.503	17.067	15.666	0.548	OK				
			No abnormality	adversely		No abno								
	Apearance	After test	affecting the			affecting the performance shall				OK				
			performance sh	all occur.		occur.								
		·												
М	Surface Mount Soldera	ability Test												
	Solder Wetting Area	After test	95 MIN.	%	5		95 N	IN.		OK				
N	Resistance to Reflow	Soldering Heat												
	Contact resistance	After test	25 MAX	mΩ		15.901	17.600	14.380	1.020	OK				
			No abnormality	adversely	5	No abno	rmality a	adversel	У					
	Apearance	After test	affecting the	′ ′ ′ 5				· 5		I	the per		-	ОК
	•		performance sh	all occur.		occur.								
			1.											





Graph-1.Durability

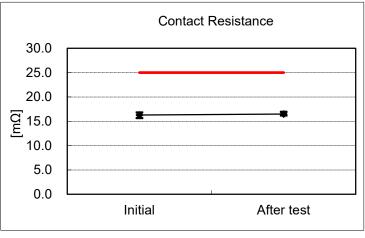
Graph-2.Shock

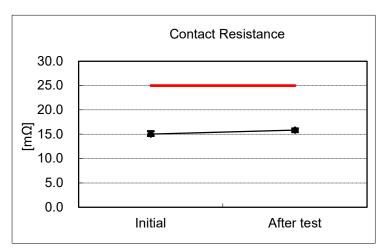




Graph-3.Vibration

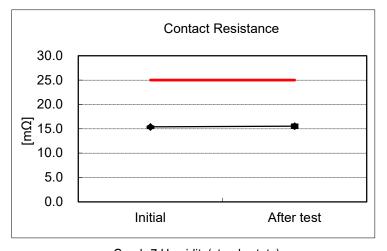
Graph-4.Cold Test

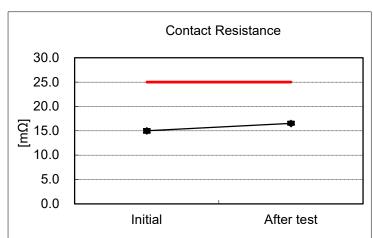




Graph-5.Heat Test

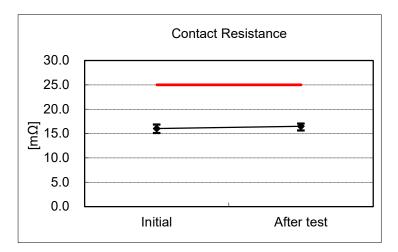
Graph-6.Thermal Shock





Graph-7.Humidity(steady state)

Graph-8.H2S Gas



Graph-9.Salt Water Spray